

# **AN1603-433**

## **Multilayer Chip Antenna for 433MHz Wireless Communication**



## AN1603 Multilayer Chip Antenna

### ◆ Features

- Light weight and low profile 16.0mm(L)X3.1mm(W)X1.65mm(H)
- Omni-directional in azimuth
- Lead (Pb) Free

### ◆ Applications

- 433MHz wireless communications
- 433MHz Modules
- Other ISM band 420MHz~660MHz Wireless Application

## Specifications

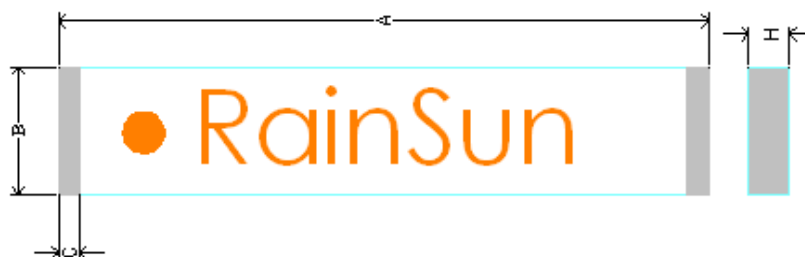
|                       |                  |
|-----------------------|------------------|
| Center frequency      | 433MHz           |
| Peak gain             | 0.5dBi           |
| Operation temperature | -40 ~ +85 °C     |
| Storage temperature   | -40 ~ +85 °C     |
| VSWR                  | 2.0 (Max)        |
| Input Impedance       | 50 Ohm           |
| Power handling        | 3W (Max)         |
| Bandwidth             | 8MHz             |
| Azimuth beamwidth     | Omni-directional |
| Polarization          | Linear           |

## Pin configuration



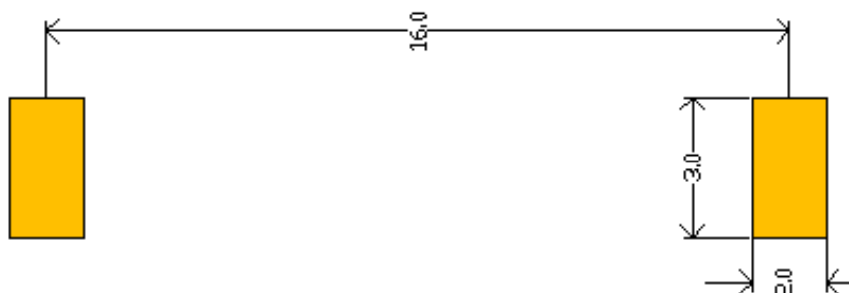
| Pin No | Pin assignment     |
|--------|--------------------|
| 1      | Feed termination   |
| 2      | Feed point mark    |
| 3      | Solder termination |

## Dimensions

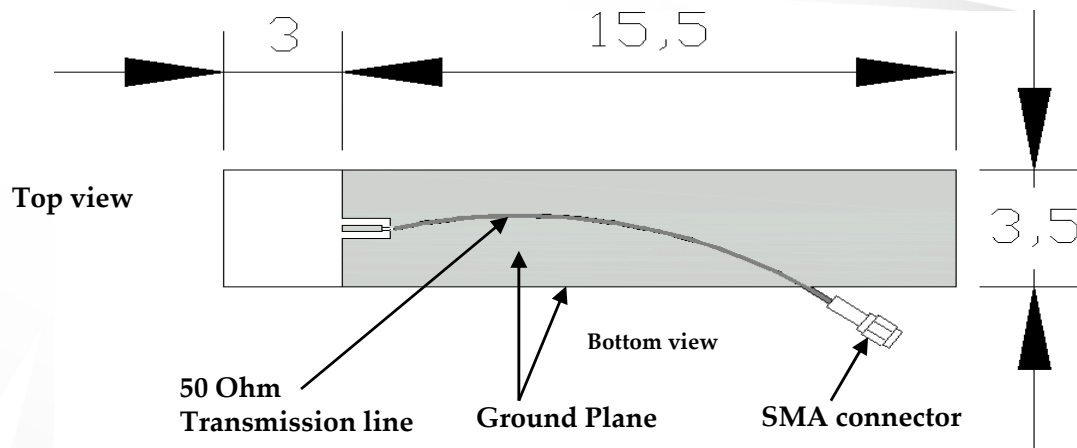


| Symbol | Dimensions (mm)  |
|--------|------------------|
| A      | $16.00 \pm 0.10$ |
| B      | $3.10 \pm 0.10$  |
| C      | $0.60 \pm 0.05$  |
| H      | $1.65 \pm 0.20$  |

## PCB foot printer



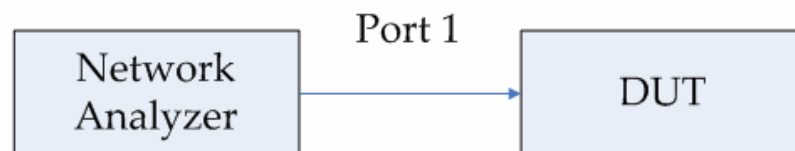
## Recommended Test Board Pattern



Unit : cm  
Board thickness : 0.6mm  
Board material : FR4

**Fig-1**

## Testing Setup



## Measurement



### Testing Instrument:

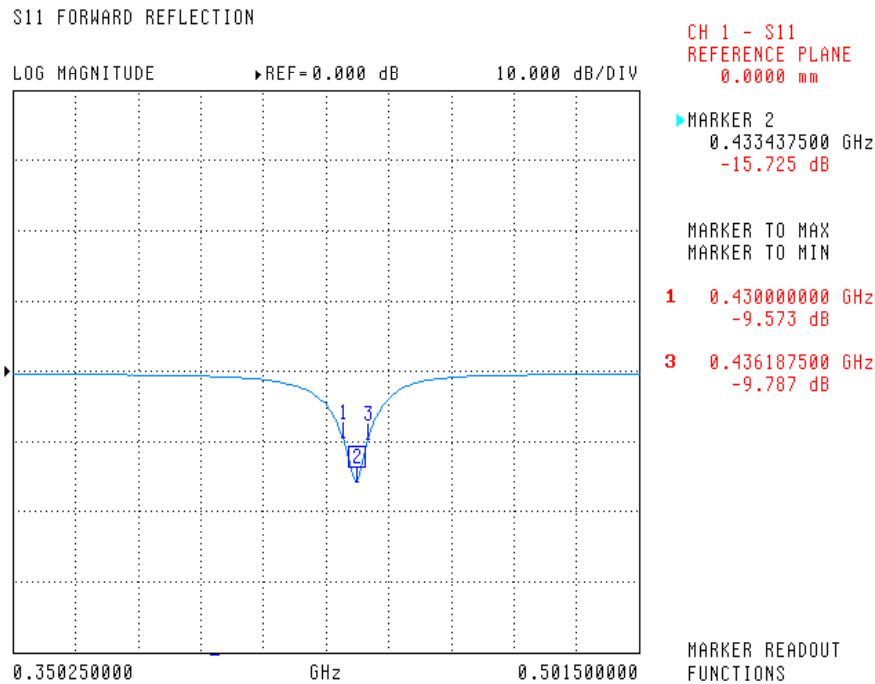
Anritsu 37369C VNA(Vector Network Analyzer)

VNA calibrate with 1 path reflection only calibration sequence on test board feed point.

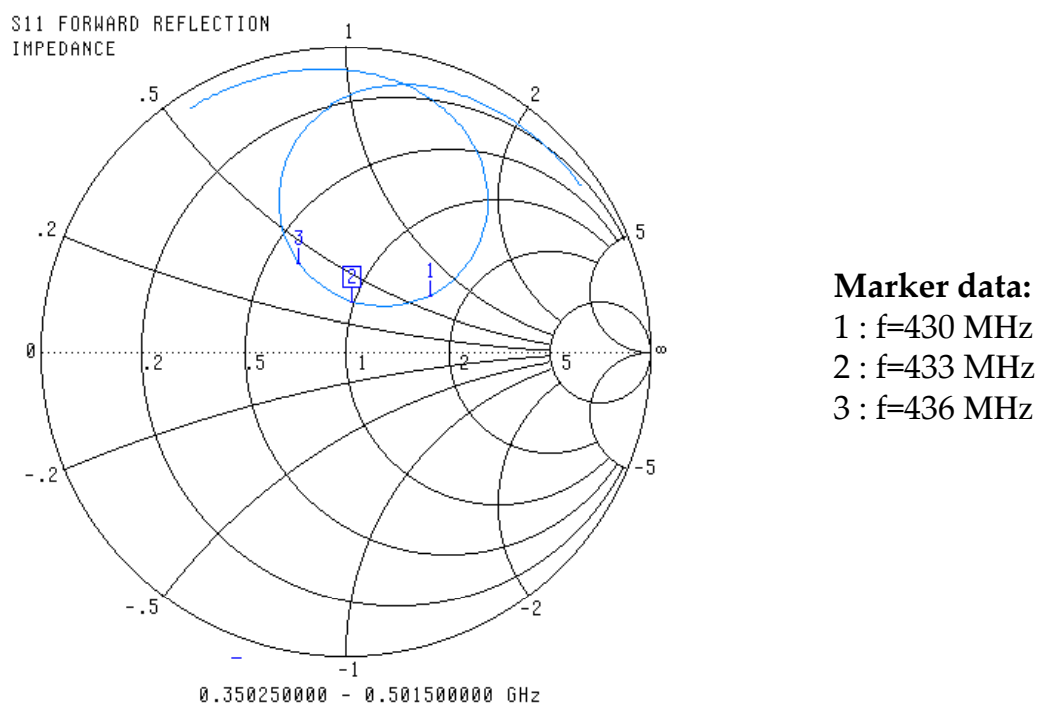
The test board dimension and it's layout is the same as recommended Test Board.

# Typical Electrical Characteristics

## Return loss

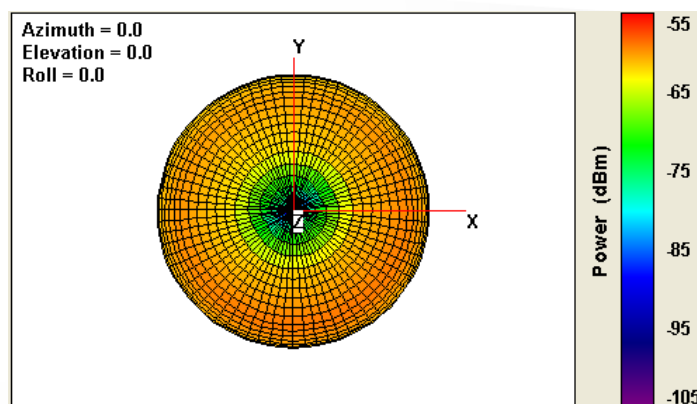


## 433 MHz Smith Chart



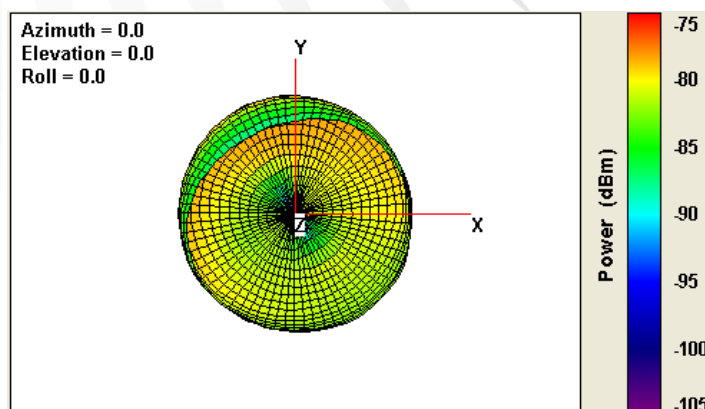
## 3D Pattern

**Theta**



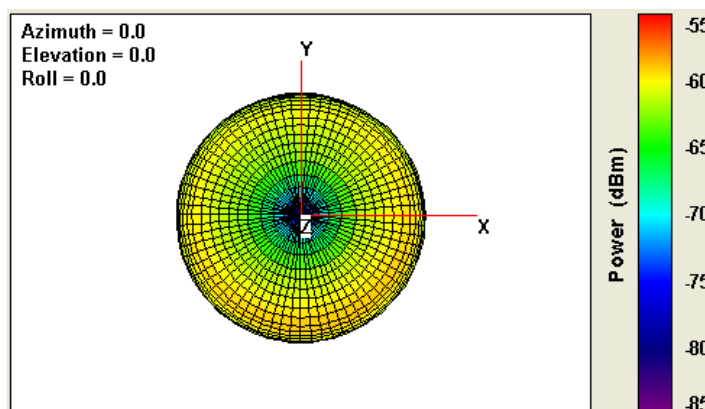
**Free-Spec, 433 MHz**

**Phi**



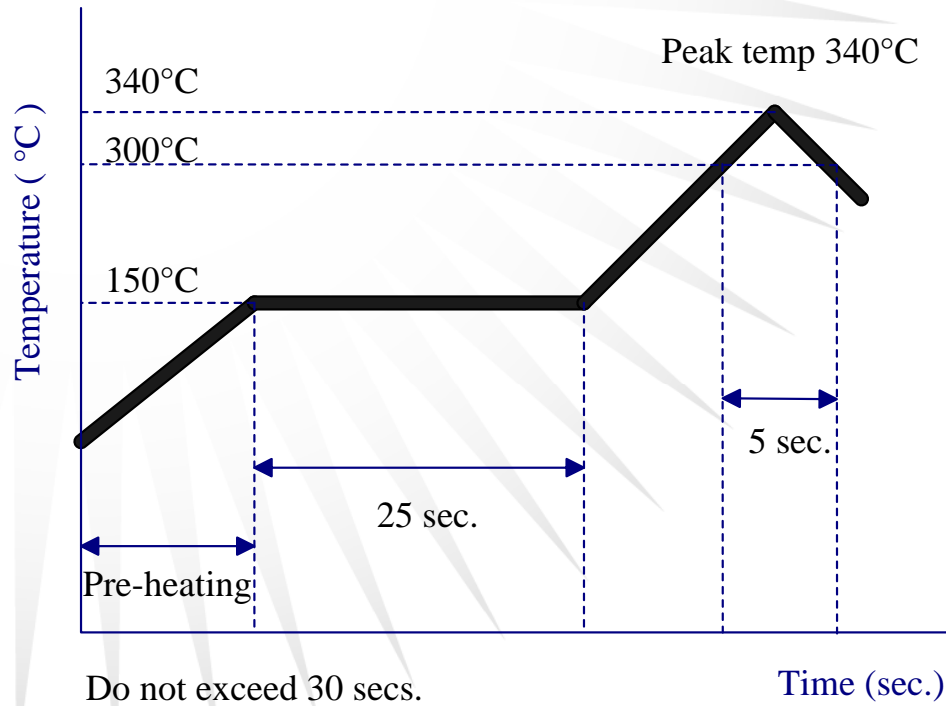
**Free-Spec, 433 MHz**

**Total**

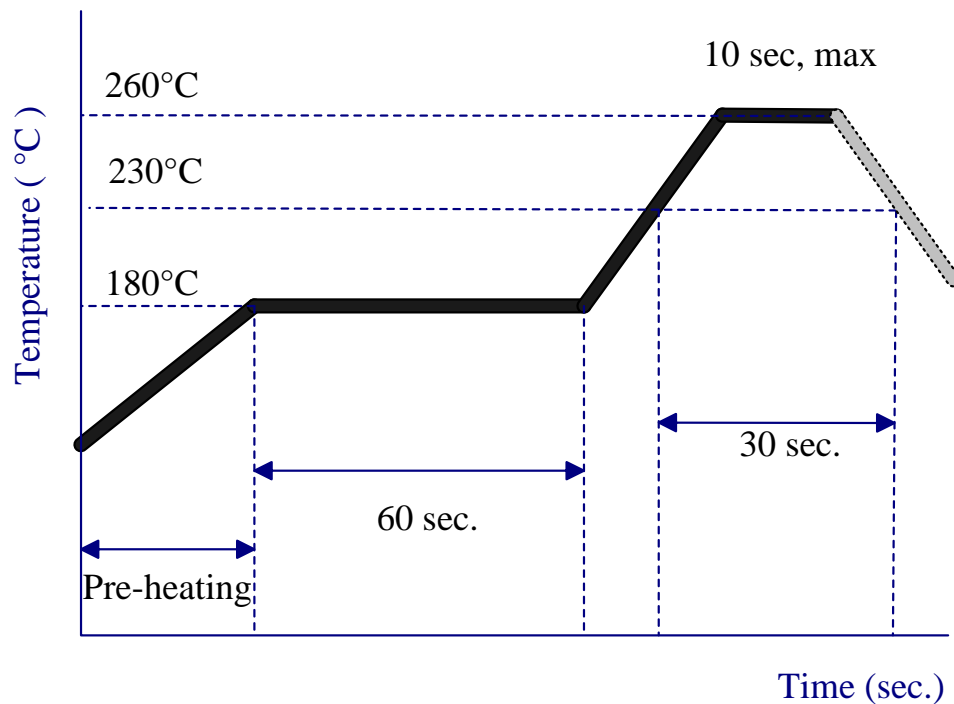


**Free-Spec, 433 MHz**

## Typical Soldering Profile for Lead-free Process

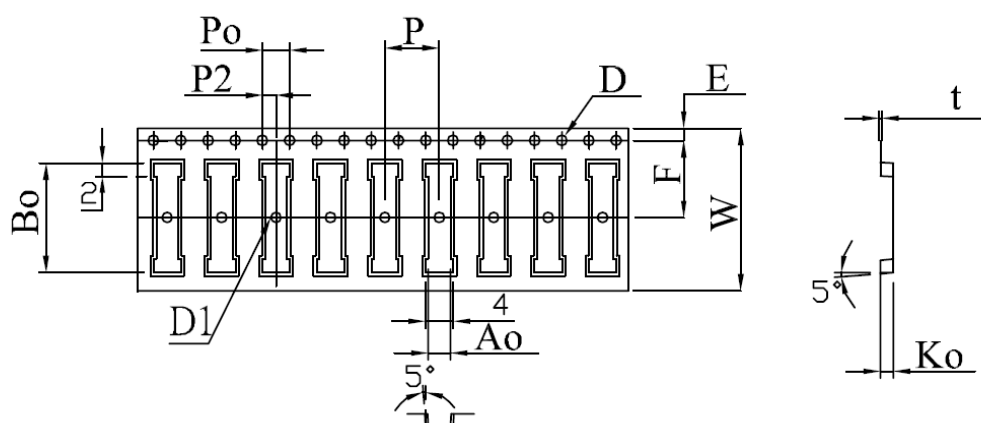


### Reflow Soldering



# Packing

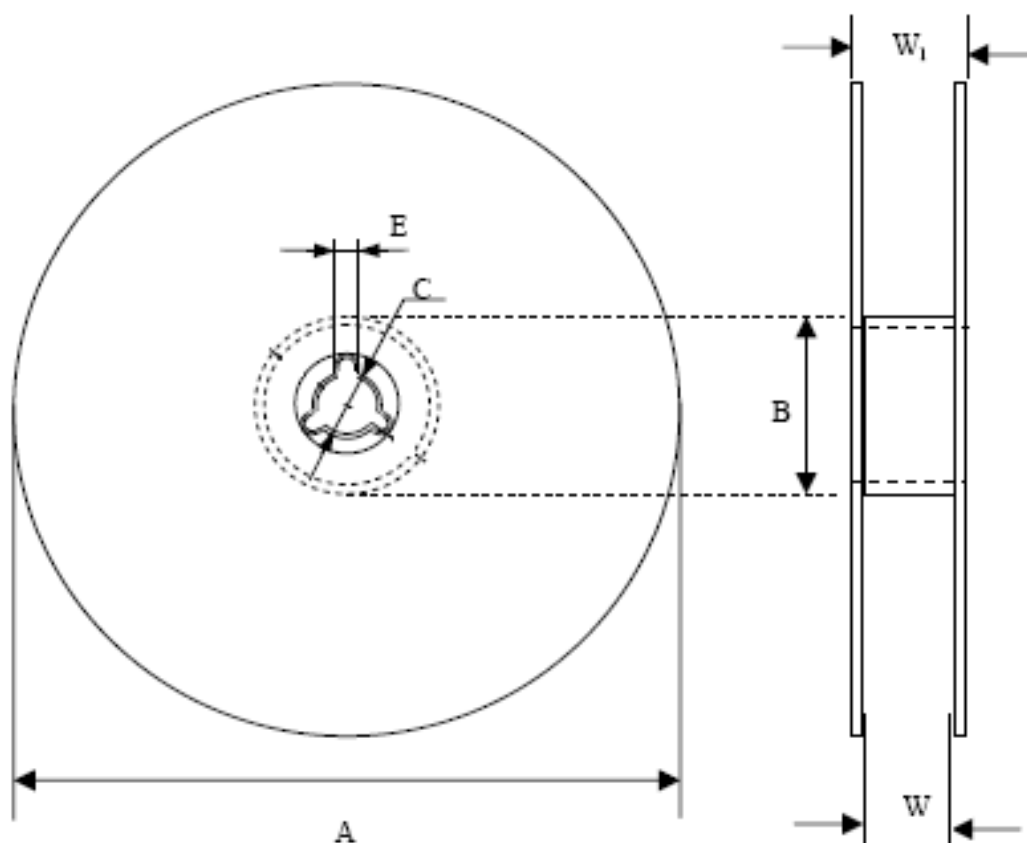
## Blister Tape Specifications



| Symbol | Dimension | Tolerance        | Unit |
|--------|-----------|------------------|------|
| W      | 24.00     | $\pm 0.30$       | mm   |
| P      | 8.00      | $\pm 0.10$       | mm   |
| P2     | 2.00      | $\pm 0.10$       | mm   |
| Ao     | 4.70      | + 0.10<br>- 3.20 | mm   |
| Bo     | 16.20     | $\pm 0.10$       | mm   |
| Ko     | 1.90      | $\pm 0.10$       | mm   |
| F      | 11.50     | $\pm 0.10$       | mm   |
| E      | 1.75      | $\pm 0.10$       | mm   |
| D      | 1.50      | + 0.10<br>- 0.00 | mm   |
| Po     | 4.00      | $\pm 0.10$       | mm   |
| t      | 0.30      | $\pm 0.05$       | mm   |



## Reel Specifications



| Quantity<br>Per Reel | Tape Width<br>(mm) | A<br>(mm) | C<br>(mm) | B (mm)    | E<br>(mm) | W<br>(mm) | W <sub>1</sub><br>(mm) |
|----------------------|--------------------|-----------|-----------|-----------|-----------|-----------|------------------------|
| 3,000                | 24                 | 330±1     | 13.0±0.5  | 100.0±0.5 | 2.2±0.5   | 24.0±0.5  | 28.9±0.2               |